

Low $V_{CE(sat)}$ PNP Transistors 60 V, 2 A

NSS60200DMT

onsemi's e²PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and LED lightning, power management...etc. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Wettable Flank Package for optimal Automated Optical Inspection (AOI); NSS60200DMTWTBG – Wettable Flanks Device
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V_{CEO}	60	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	6	Vdc
Collector Current – Continuous	I_C	2	A
Collector Current – Peak	I_{CM}	3	A

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

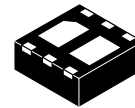
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance Junction-to-Ambient (Notes 1 and 2)	$R_{\theta JA}$	55	$^\circ\text{C/W}$
Total Power Dissipation per Package @ $T_A = 25^\circ\text{C}$ (Note 2)	P_D	2.27	W
Thermal Resistance Junction-to-Ambient (Note 3)	$R_{\theta JA}$	69	$^\circ\text{C/W}$
Power Dissipation per Transistor @ $T_A = 25^\circ\text{C}$ (Note 3)	P_D	1.8	W
Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

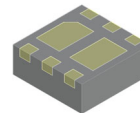
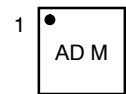
1. Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Dual Operation).
2. P_D per Transistor when both are turned on is one half of Total P_D or 1.13 Watts.
3. Per JESD51-7 with 100 mm² pad area and 2 oz. Cu (Single-Operation).

60 Volt, 2 Amp PNP Low $V_{CE(sat)}$ Transistors

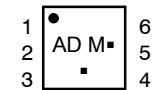
MARKING DIAGRAM



WDFN6
CASE 506AN



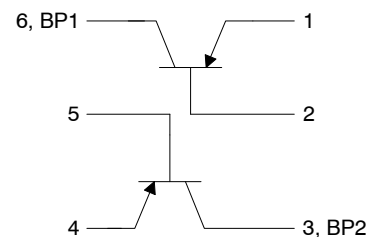
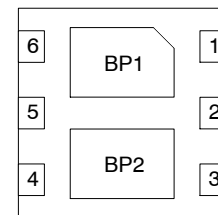
WDFNW6
CASE 515AM



AD = Specific Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping [†]
NSS60200DMTTBG	WDFN6 (Pb-Free)	3000/Tape & Reel
NSV60200DMTWTBG	WDFNW6 (Pb-Free)	3000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NSS60200DMT

Table 1. ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage ($I_C = -10\text{ mA}$, $I_B = 0$)	$V_{(BR)CEO}$	-60			V
Collector-Base Breakdown Voltage ($I_C = -0.1\text{ mA}$, $I_E = 0$)	$V_{(BR)CBO}$	-80			V
Emitter-Base Breakdown Voltage ($I_E = -0.1\text{ mA}$, $I_C = 0$)	$V_{(BR)EBO}$	-6			V
Collector Cutoff Current ($V_{CB} = -60\text{ V}$, $I_E = 0$)	I_{CBO}			-100	nA
Emitter Cutoff Current ($V_{BE} = -5.0\text{ V}$)	I_{EBO}			-100	nA

ON CHARACTERISTICS

DC Current Gain (Note 4) ($I_C = -100\text{ mA}$, $V_{CE} = -2.0\text{ V}$) ($I_C = -500\text{ mA}$, $V_{CE} = -2.0\text{ V}$) ($I_C = -1\text{ A}$, $V_{CE} = -2.0\text{ V}$) ($I_C = -2\text{ A}$, $V_{CE} = -2.0\text{ V}$)	h_{FE}	150 120 90 40	230 180 140 80		
Collector-Emitter Saturation Voltage (Note 4) ($I_C = -500\text{ mA}$, $I_B = -50\text{ mA}$) ($I_C = -700\text{ mA}$, $I_B = -7.0\text{ mA}$) ($I_C = -1\text{ A}$, $I_B = -50\text{ mA}$) ($I_C = -1\text{ A}$, $I_B = -100\text{ mA}$) ($I_C = -2\text{ A}$, $I_B = -200\text{ mA}$)	$V_{CE(sat)}$		-0.115 -0.295 -0.250 -0.200 -0.365	-0.160 -0.420 -0.350 -0.300 -0.450	V
Base-Emitter Saturation Voltage (Note 4) ($I_C = -500\text{ mA}$, $I_B = -50\text{ mA}$) ($I_C = -1\text{ A}$, $I_B = -50\text{ mA}$) ($I_C = -1\text{ A}$, $I_B = -100\text{ mA}$)	$V_{BE(sat)}$			-1.0 -1.0 -1.1	V
Base-Emitter Turn-on Voltage (Note 4) ($I_C = -500\text{ mA}$, $V_{CE} = -2.0\text{ V}$)	$V_{BE(on)}$			-0.9	V

DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 10\text{ V}$, $f = 1.0\text{ MHz}$)	C_{obo}		18		pF
Cutoff Frequency ($I_C = 50\text{ mA}$, $V_{CE} = 2.0\text{ V}$, $f = 100\text{ MHz}$)	f_T		155		MHz

SWITCHING TIMES

Delay Time ($V_{CC} = -10\text{ V}$, $I_C = -0.5\text{ A}$, $I_{B1} = -25\text{ mA}$, $I_{B2} = 25\text{ mA}$)	t_d		15		ns
Rise Time ($V_{CC} = -10\text{ V}$, $I_C = -0.5\text{ A}$, $I_{B1} = -25\text{ mA}$, $I_{B2} = 25\text{ mA}$)	t_r		13		ns
Storage Time ($V_{CC} = -10\text{ V}$, $I_C = -0.5\text{ A}$, $I_{B1} = -25\text{ mA}$, $I_{B2} = 25\text{ mA}$)	t_s		360		ns
Fall Time ($V_{CC} = -10\text{ V}$, $I_C = -0.5\text{ A}$, $I_{B1} = -25\text{ mA}$, $I_{B2} = 25\text{ mA}$)	t_f		22		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Condition: Pulse Width = 300 μsec , Duty Cycle $\leq 2\%$

TYPICAL CHARACTERISTICS

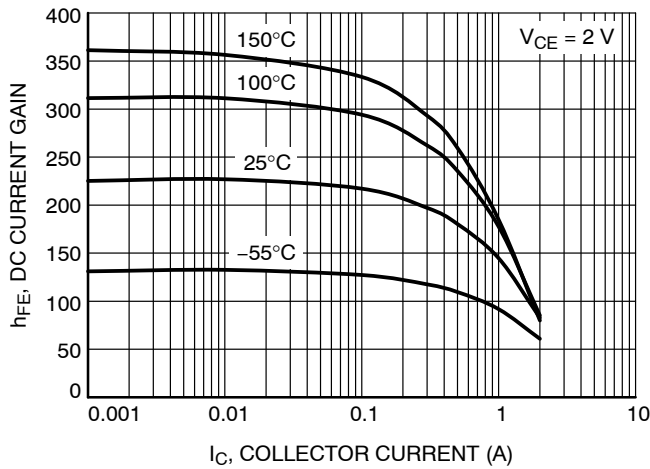


Figure 1. DC Current Gain

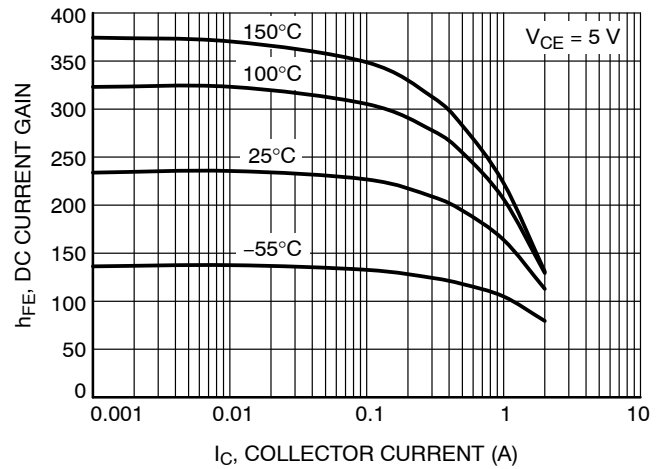


Figure 2. DC Current Gain

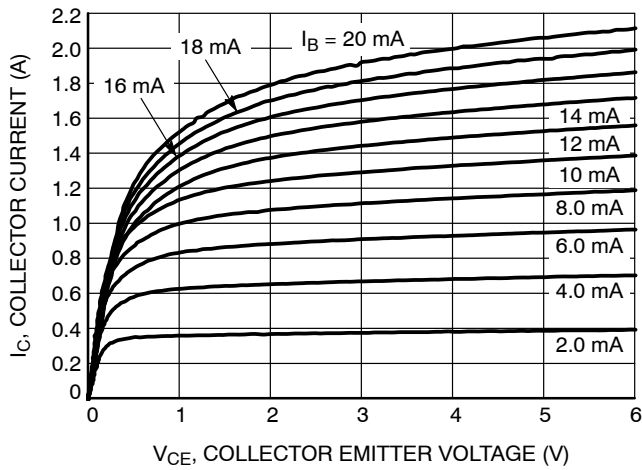


Figure 3. Collector Current as a Function of Collector Emitter Voltage

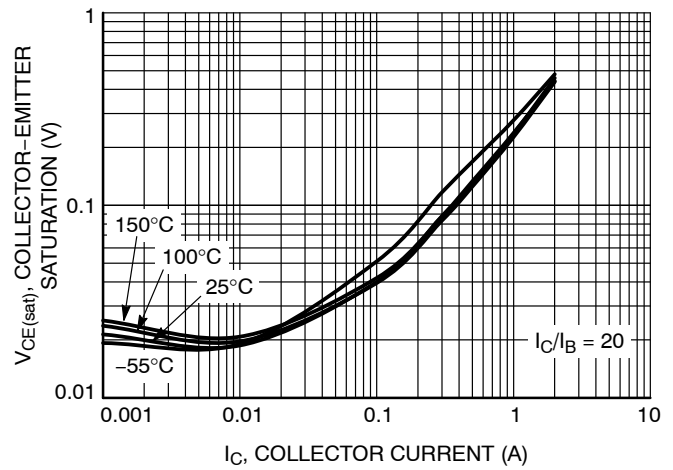


Figure 4. Collector-Emitter Saturation Voltage

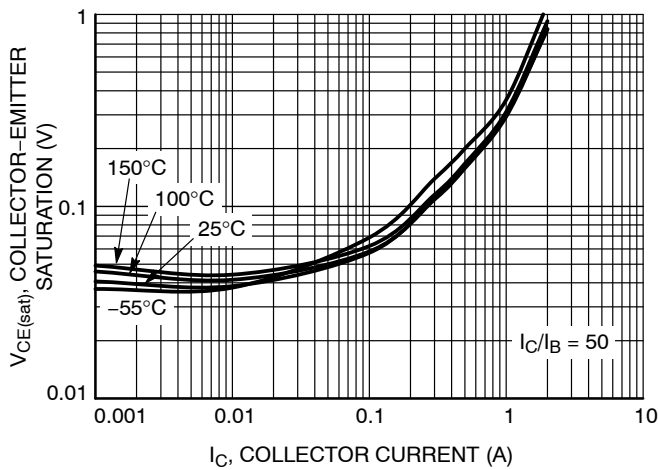


Figure 5. Collector-Emitter Saturation Voltage

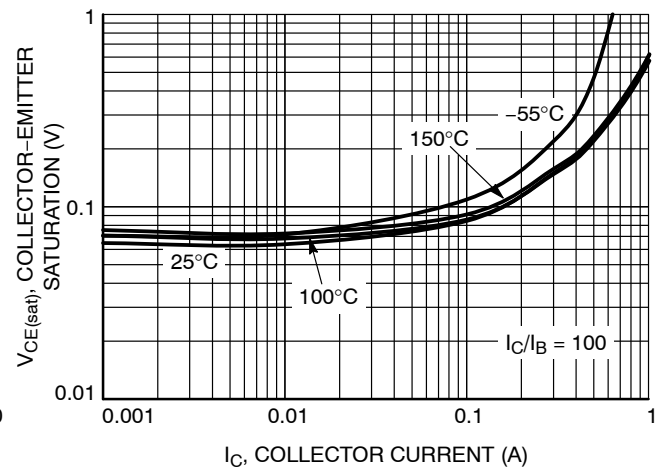


Figure 6. Collector-Emitter Saturation Voltage

TYPICAL CHARACTERISTICS

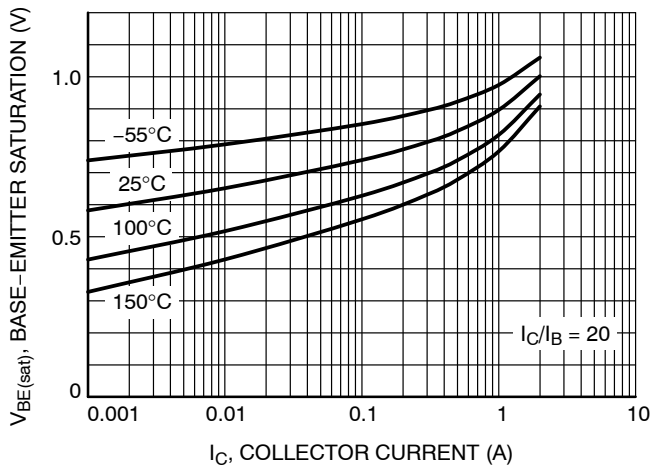


Figure 7. Base-Emitter Saturation Voltage

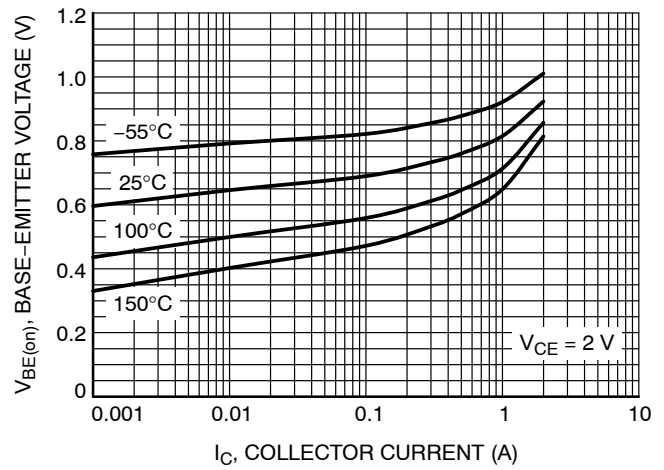


Figure 8. Base-Emitter "ON" Voltage

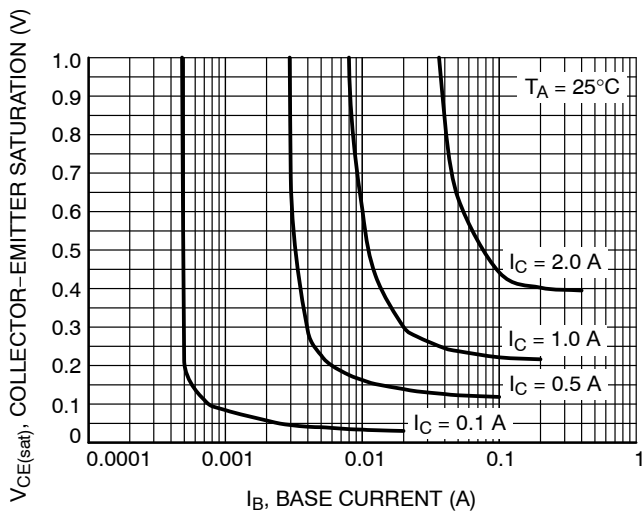


Figure 9. Collector Saturation Region

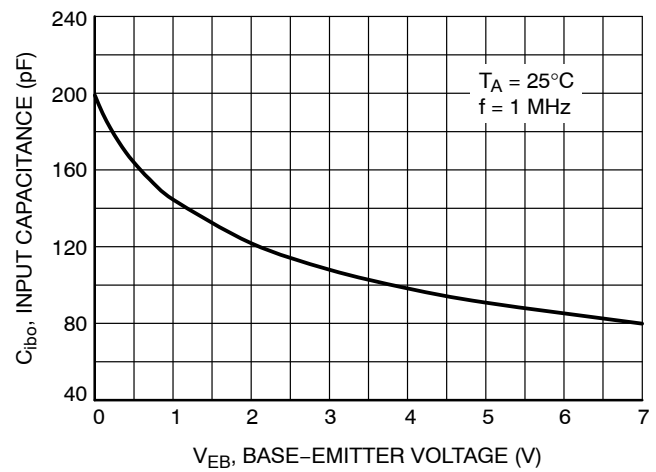


Figure 10. Input Capacitance

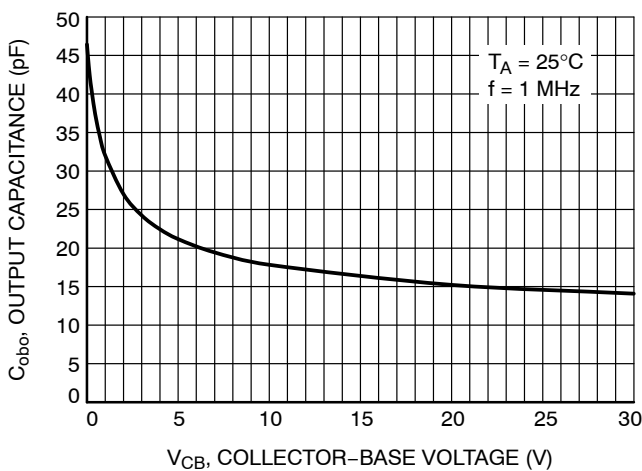


Figure 11. Output Capacitance

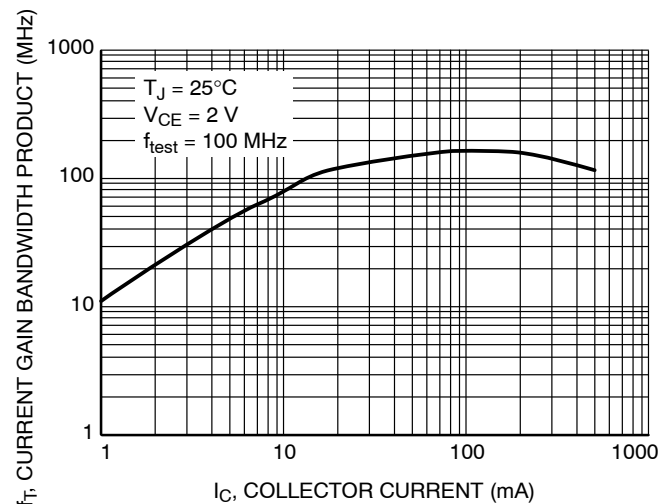


Figure 12. f_T , Current Gain Bandwidth Product

NSS60200DMT

TYPICAL CHARACTERISTICS

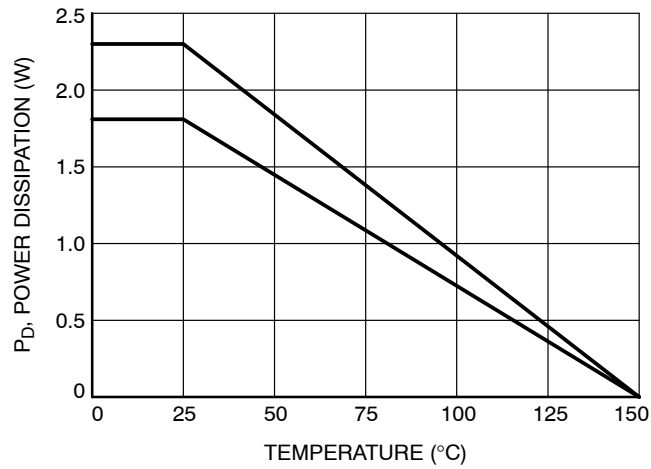


Figure 13. Power Derating

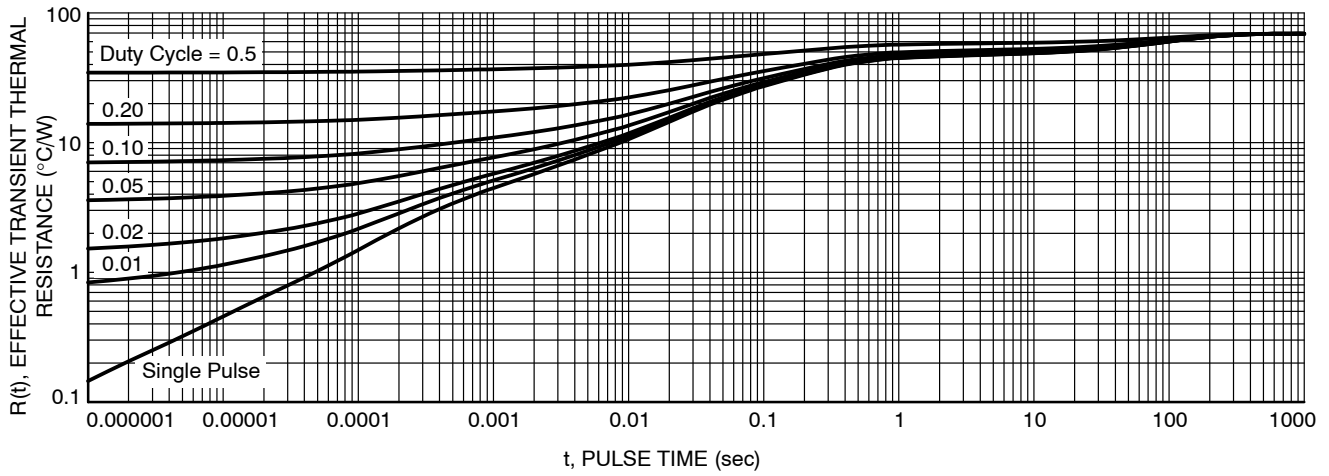


Figure 14. Thermal Resistance by Transistor

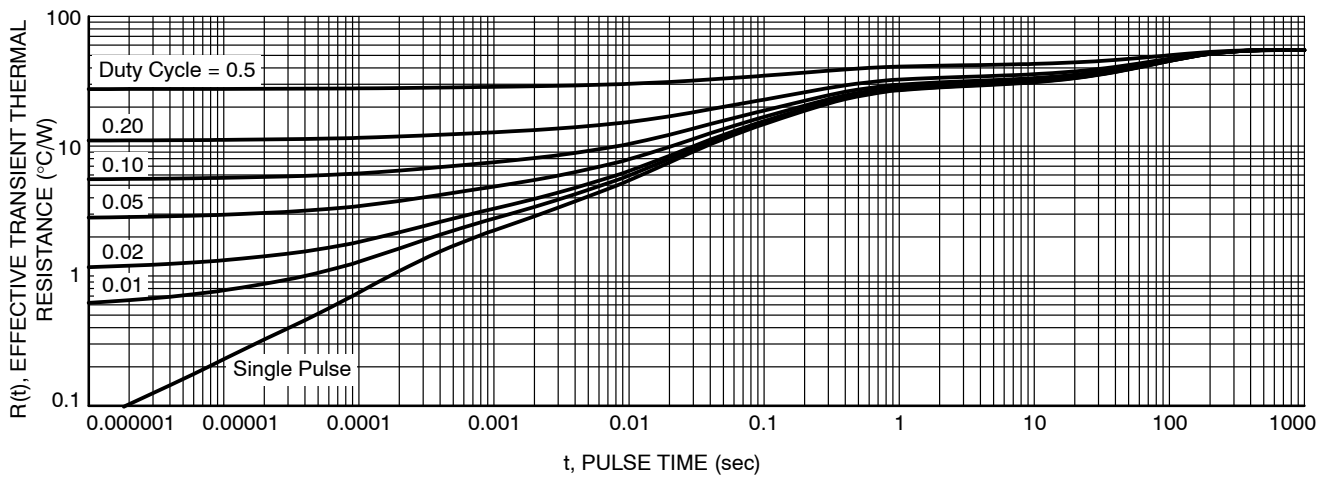


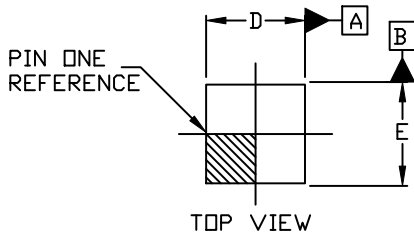
Figure 15. Thermal Resistance for Both Transistors

PACKAGE DIMENSIONS

WDFNW6 2x2, 0.65P

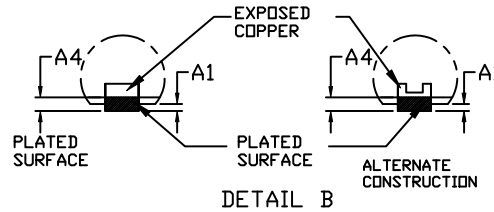
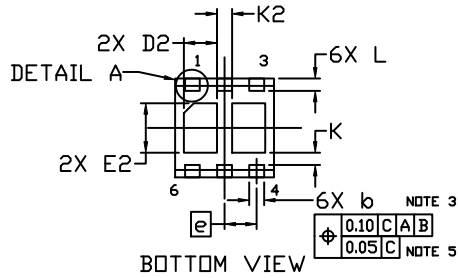
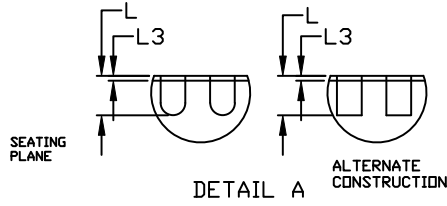
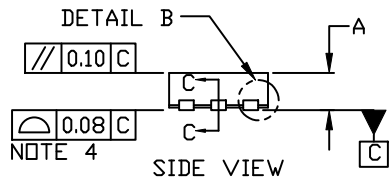
CASE 515AM

ISSUE O

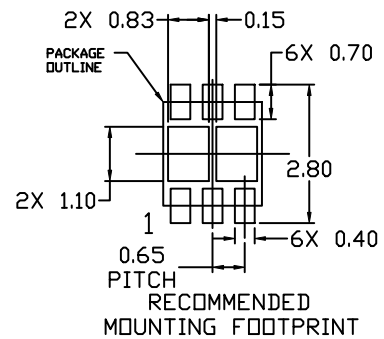


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION *b* APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. POSITIONAL TOLERANCE APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

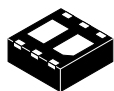


DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.70	0.75	0.80
A1	0.00	---	0.05
A3	0.20 REF		
A4	0.10	---	---
b	0.25	0.30	0.35
D	1.90	2.00	2.10
D2	0.62	0.67	0.72
E	1.90	2.00	2.10
E2	0.90	1.00	1.10
e	0.65 BSC		
K	0.20 REF		
K2	0.305 REF		
L	0.20	0.25	0.30
L3	0.05 REF		



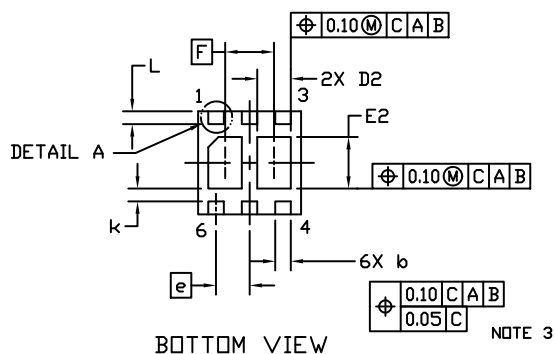
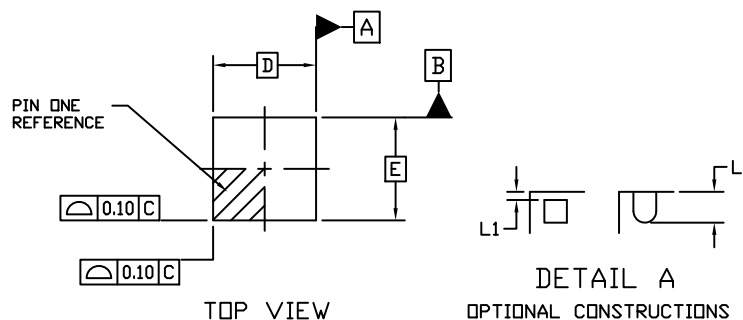
* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



WDFN6 2x2, 0.65P
CASE 506AN
ISSUE H

DATE 25 JAN 2022



GENERIC MARKING DIAGRAM*



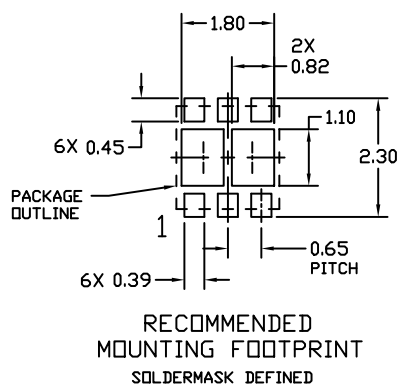
XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION **b** APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN.	MAX.
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.25	0.35
D	2.00 BSC	
D2	0.57	0.77
E	2.00 BSC	
E2	0.90	1.10
e	0.65 BSC	
F	0.95 BSC	
k	0.25 REF	
L	0.20	0.30
L1	---	0.10



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